



MJ N-Channel Super Trench Power MOSFET

Description

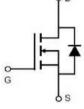
The MJXP40T15G uses Super Trench technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

Application

DC/DC Converter

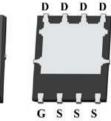
General Features

- V_{DS}=40V,I_D=150A
 R_{DS(ON)}=1.6mΩ (typical) @ V_{GS}=10V
 R_{DS(ON)}=1.9mΩ (typical) @ V_{GS}=4.5V
- Excellent gate charge x RDS(on) product(FOM)
- Very low on-resistance RDS(on)
- 150°C operating temperature
- Pb-free lead plating
- 100% UIS tested



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DDDD



Ideal for high-frequency switching and synchronous rectification

Schematic Diagram

Top View

Bottom View

100% UIS TESTED! 100% ΔVds TESTED!

SSSG

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJXP40T15G	MJXP40T15G	DFN5X6-8L	-	e	÷

Absolute Maximum Ratings (Tc=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	Vds	40	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous (Silicon Limited)	ld	150	А
Drain Current-Continuous (Tc =100°C)	ID(100℃)	106	А
Pulsed Drain Current (Package Limited)	Ідм	600	А
Maximum Power Dissipation	PD	135	W
Derating factor		1.08	W/°C
Single pulse avalanche energy (Note 5)	Eas	720	mJ
Operating Junction and Storage Temperature Range	ТЈ,Тѕтс	-55 To 150	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rejc	0.93	°C/W	
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Electrical Characteristics (Tc=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Uni
Off Characteristics		1		1	1	1
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =250µA	40	-	-	V
Zero Gate Voltage Drain Current	loss	V _{DS} =40V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	lgss	VDS=±20V,VDS=0V	-	-	±100	nA
On Characteristics (Note 3)	I	1	1			
Gate Threshold Voltage	VGS(th)	Vos=Vgs,Io=250µA	1.2	1.5	2.2	V
Durin Original Original Designation	Descou	V _{GS} =10V,I _D =75A	-	1.6	1.8	m۵
Drain-Source On-State Resistance	Rds(on)	V _{GS} =4.5V,I _D =75A	-	1.9	2.3	mΩ
Forward Transconductance	gfs	Vds=5V,Id=75A	-	80	-	s
Dynamic Characteristics (Note 4)		1		1	1	
Input Capacitance	Clss		_	6000	7150	PF
Output Capacitance	Coss	V _{DS} =20V,V _{GS} =0V F=1.0MHz	-	1450	1700	PF
Reverse Transfer Capacitance	Crss	-	-	100	145	PF
Switching Characteristics (Note 4)		1	1		1	
Turn-on Delay Time	td(on)		_	12.5	-	nS
Turn-on Rise Time	tr			7.0	-	nS
Turn-Off Delay Time	td(off)	Vgs=10V,Rg=1.6Ω	_	50	-	nS
Turn-Off Fall Time	tr	-	_	8.5	-	nS
Total Gate Charge	Qg		_	95	115	nC
Gate-Source Charge	Qgs	VDS=20V,ID=75A VGS=10V		15	-	nC
Gate-Drain Charge	Qgd			11	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage	Vsd	V _{GS} =0V,Is=75A	-	-	1.2	V
Diode Forward Current	ls		_	-	150	A
Reverse Recovery Time	trr			-	31	nS
Reverse Recovery Charge		TJ=25°C,IF= Is di/dt= 100A/µs ^(Note 3)			110	nC
Reverse Recovery Charge	Qrr		_		110	

Notes:

① Repetitive Rating: Pulse width limited by maximum junction temperature.

(2) Surface Mounted on FR4 Board, t \leq 10 sec.

③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.

(4) Guaranteed by design, not subject to production

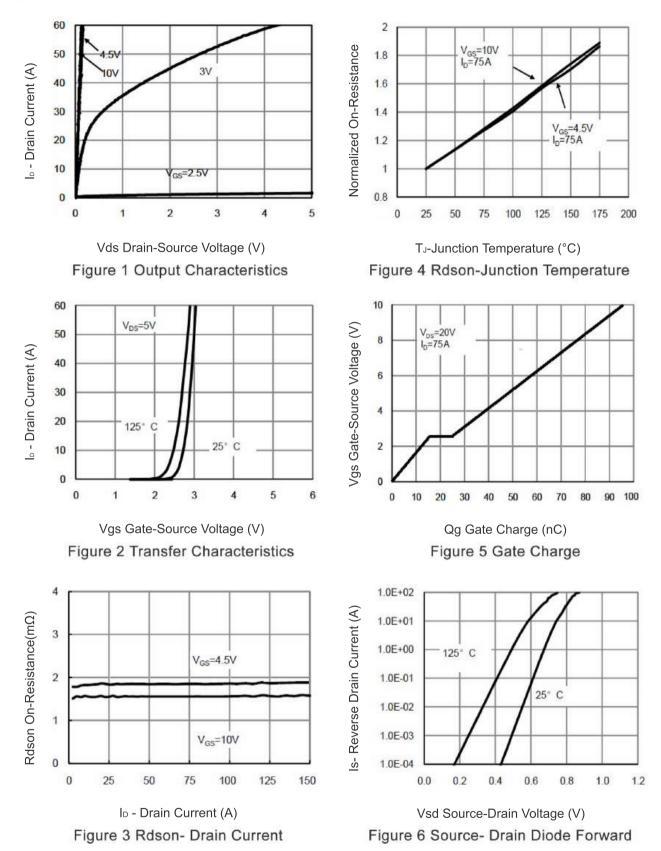
(5) EAS condition : Tj=25°C, VDD=20V, VG=10V, L=0.5mH, Rg=25\Omega





Typical Electrical and Thermal Characteristics

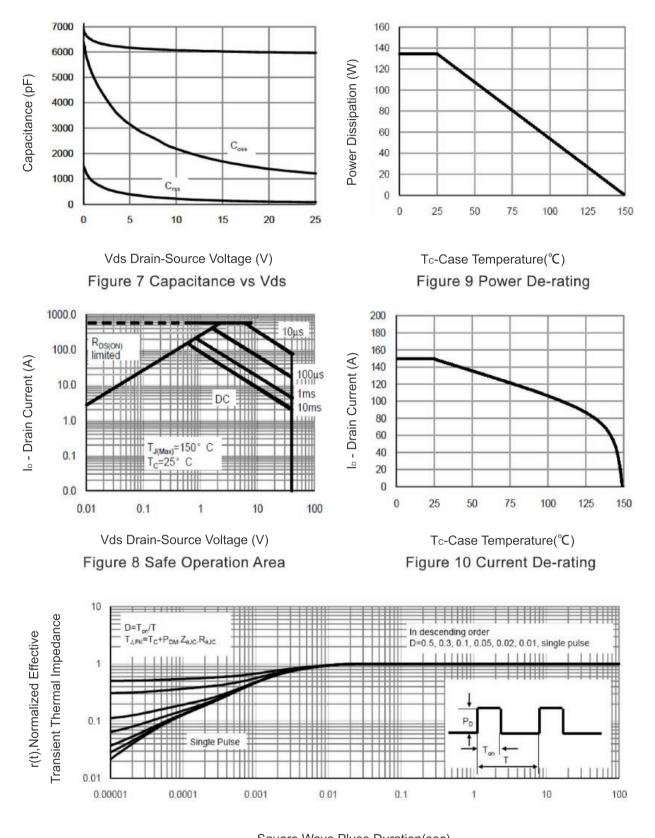
RoHS







MJXP40T15G

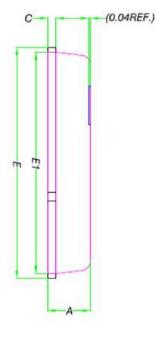


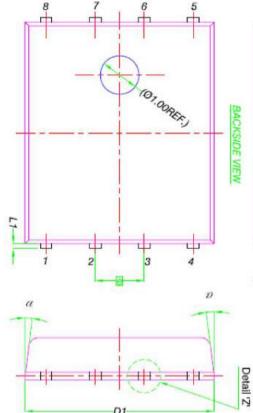
Square Wave Pluse Duration(sec) Figure 11 Normalized Maximum Transient Thermal Impedance

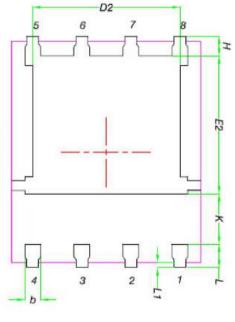


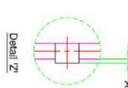


DFN5X6-8L Package Information









		ILLIMET	EDC
DIM.	MIN.	NOM.	MAX
A	0.90	1.00	1.10
41	0	-	0.05
	0.33	0.41	0.51
;	0.20	0.25	0.30
)1	4.80	4.90	5.00
)2	3.61	3.81	3.96
Ē	5.90	6.00	6.10
1	5.70	5.75	5.80
E2	3.38	3.58	3.78
1	5.70	5.75	5.8

0.41

1.10

0.51

0.06

0°

Н

Κ

L

L1

α

0.51

-

0.61

0.13

-

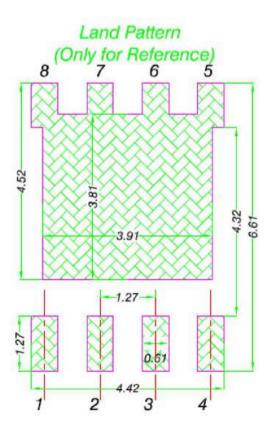
0.61

-

0.71

0.20

12°







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